

**DECLARATION UNDER 35 USC §371(c)(4) FOR  
PCT APPLICATION FOR UNITED STATES PATENT**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below under my name;

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought, namely the invention entitled: VEHICLE BODY-REINFORCEMENT DISPOSITION STRUCTURE

described and claimed in international application number PCT/IP02/06572 filed June 28, 2002.

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

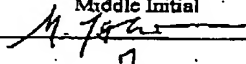
I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56.

Under Title 35, U.S. Code §119, the priority benefits of the following foreign application(s) filed by me or my legal representatives or assigns within one year prior to my international application are hereby claimed:

The following application(s) for patent or inventor's certificate on this invention were filed in countries foreign to the United States of America either (a) more than one year prior to my international application, or (b) before the filing date of the above-named foreign priority application(s):

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO OLIFF & BERRIDGE, PLC, CUSTOMER NUMBER 25944, TELEPHONE (703) 836-6400.

I hereby declare that I have reviewed and understand the contents of this Declaration, and that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1	<b>Typewritten Full Name of Sole or First Inventor:</b>	Michiya		IGARASHI
		Given Name	Middle Initial	Family Name
2	<b>Inventor's Signature:</b>			
3	<b>Date of Signature:</b>	16	7	08
		Month	Day	Year
	<b>Residence:</b>	Nagoya-shi	Aichi	JAPAN
		City	State or Province	Country
	<b>Citizenship:</b>	JAPAN		
	<b>Post Office Address:</b>	5-15, Nishiki 1-chome, Naka-ku,		
	<b>(Insert complete mailing address, including country)</b>	Nagoya-shi, Aichi 460-0003 JAPAN		

**Note to Inventor:** Please sign name on line 2 exactly as it appears in line 1 and insert the actual date of signing on line 3.

IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE ☒  
(Discard this page in a sole inventor application)



1 **Typewritten Full Name of Joint Inventor:** Kenichi BAMBA

2 **Inventor's Signature:** Kenichi Bamba Bamba

3 **Date of Signature:** 2 3 2005

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1 **Typewritten Full Name of Joint Inventor:** \_\_\_\_\_

2 **Inventor's Signature:** \_\_\_\_\_

3 **Date of Signature:** \_\_\_\_\_

**Residence:** \_\_\_\_\_

**Citizenship:** \_\_\_\_\_

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**(Insert complete mailing address, including country)** \_\_\_\_\_

1 **Typewritten Full Name of Joint Inventor:** \_\_\_\_\_

2 **Inventor's Signature:** \_\_\_\_\_

3 **Date of Signature:** \_\_\_\_\_

**Residence:** \_\_\_\_\_

**Citizenship:** \_\_\_\_\_

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1 **Typewritten Full Name of Joint Inventor:** \_\_\_\_\_

2 **Inventor's Signature:** \_\_\_\_\_

3 **Date of Signature:** \_\_\_\_\_

**Residence:** \_\_\_\_\_

**Citizenship:** \_\_\_\_\_

**Post Office Address:** \_\_\_\_\_

**(Insert complete mailing address, including country)** \_\_\_\_\_

**Note to Inventor:** Please sign name on line 2 exactly as it appears in line 1 and insert the actual date of signing on line 3.

This form may be executed only when attached to the first page of the Declaration and Power of Attorney of the application to which it pertains.